BGA622

Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

Small Signal Discretes



Never stop thinking

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BGA622, Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

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Previous Version: 2005-11-16					
Page	Subjects (major changes since last revision)				
All	Document layout change				
-					

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Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

SOT343

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Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

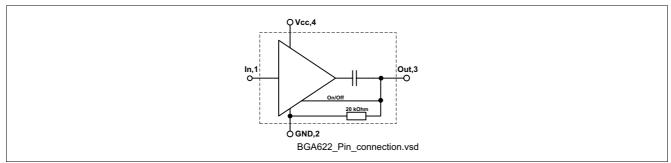
Feature

- High gain
 - $|S_{21}|^2 = 15.0 \text{ dB at } 1.575 \text{ GHz}$
 - $|S_{21}|^2$ = 14.2 dB at 1.9 GHz
- |S₂₁|² = 13.6 dB at 2.14 GHz ■ Low noise figure, *NF* = 1.0 dB at 1.575 GHz
- Operating frequency range 0.5 6 GHz
- Operating frequency range 0.5 6 G
 Typical supply valtage: 2.75 V
- Typical supply voltage: 2.75 V
- On/Off-Switch
- · Output-match on chip, input pre-matched
- Low part count
- 70 GHz $f_{\rm T}$ Silicon Germanium technology
- 2 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package



Applications

LNA for GSM, GPS, DCS, PCS, UMTS, Bluethooth, ISM and WLAN





Description

The BGA622 is a wide band low noise amplifier, based on Infineon Technologies' Silicon Germanium Technology B7HF. In order to provide the LNA in a small package the out-pin is simultaneously used for RF out and On/Off switch. This functionality can be accessed using a RF-Choke at the Out pin, where a DC level of 0 V or an open switches the device on and a DC level of V_{CC} switches the device off. While the device is switched off, it provides an insertion loss of 24 dB together with a high IIP_3 up to 20 dBm.

Туре	Package	Marking
BGA622	SOT343	BXs

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

Maximum Ratings

Table 1 Maximum ratings

Parameter	Symbol	Limit Value	Unit	
Voltage at pin $V_{\rm CC}$	V _{CC}	3.5	V	
Voltage at pin Out	V _{out}	4	V	
Current into pin In	I _{in}	0.1	mA	
Current into pin Out	I _{out}	1	mA	
Current into pin V _{CC}	I _{Vcc}	10	mA	
RF input power	P _{in}	6	dBm	
Total power dissipation, $T_{\rm S}$ < 139 °C ¹⁾	P _{tot}	35	mW	
Junction temperature	TJ	150	°C	
Ambient temperature range	T _A	-65 150	°C	
Storage temperature range	T _{STG}	-65 150	°C	
ESD capability all pins (HBM: JESD22-A114)	V _{ESD}	2000	V	
		1	1	

1) $T_{\rm S}$ is measured on the ground lead at the soldering point

Note: All Voltages refer to GND-Node

Thermal resistance

Table 2Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	300	K/W

1) For calculation of $R_{\rm thJA}$ please refer to Application Note Thermal Resistance



2 Electrical Characteristics

2.1 Electrical characteristics at T_A = 25 °C (measured according to Figure 2) V_{cc} = 2.75 V, Frequency = 1.575 GHz, unless otherwise specified

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Insertion power gain	$ S_{21} ^2$		15.0		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-27		dB	
Input return loss (On-State)	<i>RL</i> _{in}		5		dB	
Output return loss (On-State)	<i>RL</i> _{out}		12		dB	
Noise figure ($Z_{\rm S}$ = 50 Ω)	$F_{50\Omega}$		1.00		dB	<i>f</i> = 0.1 GHz
Input third order intercept point ¹⁾ (On-State)	IIP ₃		0		dBm	Δf = 1 MHz, P_{IN} = -28 dBm
Input third order intercept point ¹⁾ (Off - State)	IIP ₃		20		dBm	Δf = 1 MHz, P_{IN} = -8 dBm
Input power at 1 dB gain compression	P _{-1dB}		-16.5		dBm	
Total device off current	I _{tot-off}	130	260	420	μA	$V_{\rm CC}$ = 2.75 V, $V_{\rm out}$ = $V_{\rm CC}$
Total device on current	$I_{\rm tot-on}$	4.0	5.8	7.8	mA	V _{CC} = 2.75 V
On / Off switch control voltage	V _{on}	0		0.8	V	$V_{\rm CC}$ = 2.75 V ON-Mode: $V_{\rm out}$ = $V_{\rm on}$
	V _{off}	2.0		3.5	V	$V_{\rm CC}$ = 2.75 V OFF-Mode: $V_{\rm out}$ = $V_{\rm off}$

Table 3 Electrical Characteristics

1) IP_3 values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 to 6 GHz



2.2 Electrical characteristics at T_A = 25 °C (measured according to Figure 2) V_{cc} = 2.75 V, Frequency = 2.14 GHz, unless otherwise specified

Table 4 Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Insertion power gain	$ S_{21} ^2$		13.6		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-24		dB	
Input return loss (On-State)	RL _{in}		7		dB	
Output return loss (On-State)	<i>RL</i> _{out}		10		dB	
Noise figure ($Z_{\rm S}$ = 50 Ω)	$F_{50\Omega}$		1.05		dB	
Input third order intercept Point ¹⁾ (On-State)	IIP ₃		3		dBm	Δf = 1 MHz, P_{IN} = -28 dBm
Input third order intercept point ¹⁾ (Off-State)	IIP ₃		20		dBm	Δf = 1 MHz, P_{IN} = -8 dBm
Input power at 1 dB gain compression	P_{-1dB}		-13		dBm	

1) IP_3 values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 to 6 GHz

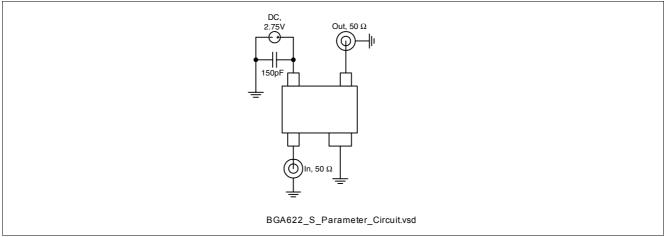
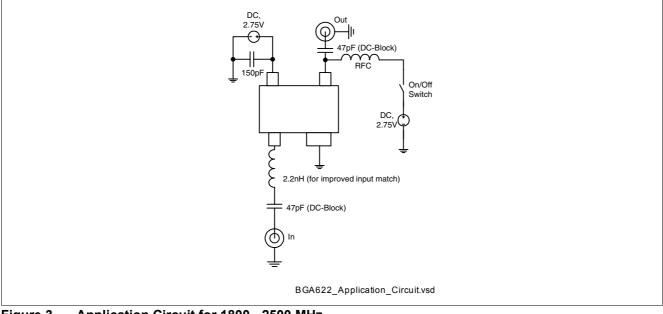


Figure 2 S-Parameter Test Circuit (loss-free microstrip test-fixture)





Electrical Characteristics

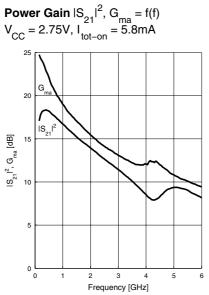


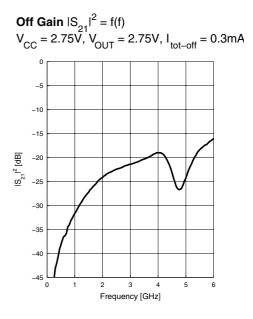
Application Circuit for 1800 - 2500 MHz Figure 3

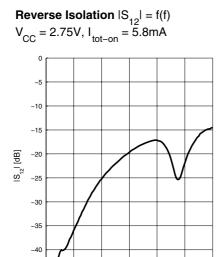


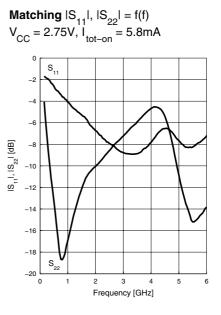
Measured Parameters

Measured Parameters 3









-45 0

1

2

3

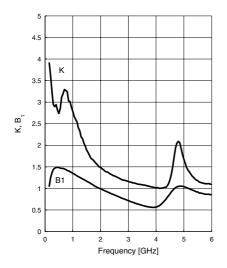
Frequency [GHz]

4

5 6

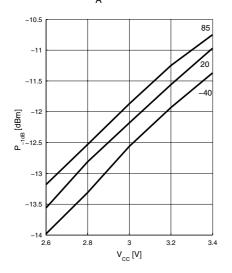


Stability K, $B_1 = f(f)$ V_{CC} = 2.75V, I_{tot-on} = 5.8mA

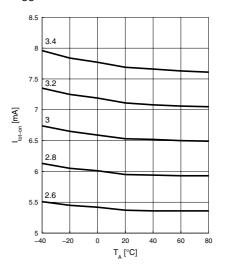


Noise Figure F = f(f) $V_{CC} = 2.75V, I_{tot-on} = 5.8mA, Z_{S} = 50\Omega$ 1.5 1.4 1.3 1.2 1.1 F [dB] 1 0.9 0.8 0.7 0.6 0.5 0.5 0 2.5 3 1 1.5 2 Frequency [GHz]

Input Compression Point P $_{-1dB}$ = f(V $_{CC})$ f = 2.14GHz, T $_{A}$ = parameter in $^{\circ}C$

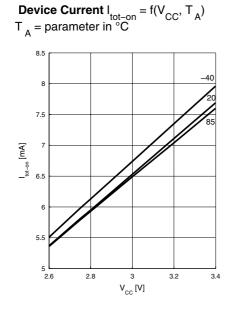


Device Current I_{tot-on} = f(T _A, V_{CC}) V_{CC} = parameter in V

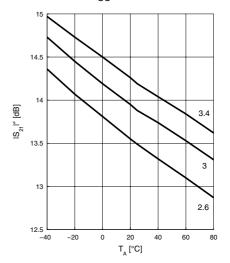




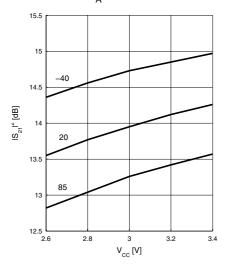
Measured Parameters



Power Gain $|S_{21}|^2 = f(T_A, V_{CC})$ f = 2.14GHz, V_{CC} = parameter in V



Power Gain $|S_{21}|^2 = f(V_{CC}, T_A)$ f = 2.14GHz, T_A = parameter in °C





Package Information

Package Information 4

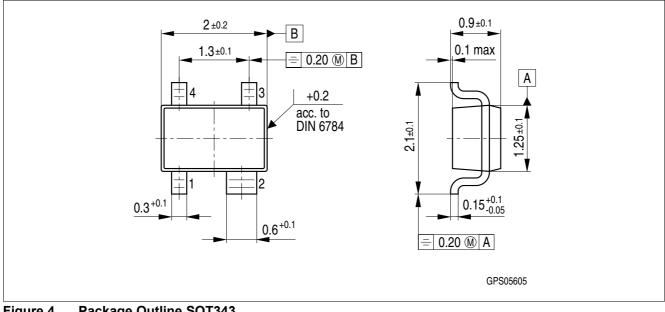


Figure 4 Package Outline SOT343

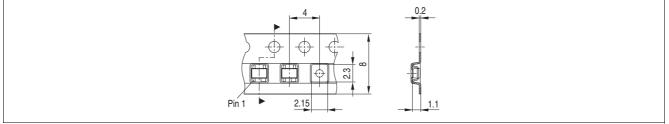


Figure 5 Tape for SOT343

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